SIMPLE SWITCHER® Portfolio



Power modules

SIMPLE SWITCHER power modules

When to use: For low-noise designs that require an extremely fast time to market and high power density

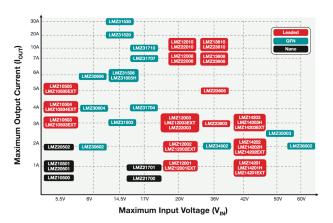
- Best in-class thermal performance—operates up to 85°C ambient with NO airflow
- Superior EMI performance—integrated shielded inductor

SIMPLE SWITCHER nano modules

When to use: For space-constrained applications that require a tiny solution size in an integrated package

- Smallest solution size–35mm²
- **High efficiency**—up to 96%
- Low output voltage ripple—less than 10 mV pk-pk
- Superior EMI performance—integrated shielded inductor

SIMPLE SWITCHER® modules











Nano power modules

Device	Output Current (A)	Input Voltage (V)	Output Voltage (V)	Freq (kHz)	EMI Tested	Package Size	Packaging
LMZ10500/01	0.65/1	2.7 to 5.5	0.6 to 3.6	2000	1	2.6 x 3 x 1.5 mm	8uSip
LMZ20501/2	1/2	2.7 to 5.5	0.8 to 3.6	3000	1	3.5 x 3.5 x 1.5 mm	8uSip
LMZ21700/1	0.65/1	3 to 17	0.9 to 6	1250 to 2500	1	3.5 x 3.5 x 1.5 mm	8uSip

Power modules

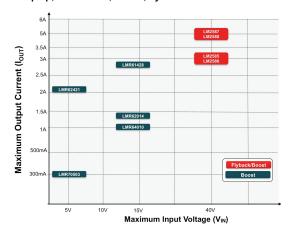
Device	Output Current (A)	Input Voltage (V)	Output Voltage (V)	Freq (kHz)	Freq Sync	Current Sharing	EMI Tested	Packaging
LMZ10503/04/05	3/4/5	2.95 to 5.5	0.8 to 5	1000	_	_	1	7TO-PMOD
LMZ12001/02/03	1/2/3	4.5 to 20	0.8 to 6	1000 max	_	_	1	7TO-PMOD
LMZ14201/02/03	1/2/3	6 to 42	0.8 to 6	1000 max	_	_	1	7TO-PMOD
LMZ14201H/02H/03H	1/2/3	6 to 42	5 to 30	1000 max	_	_	1	7TO-PMOD
LMZ12008/10	8/10	6 to 20	0.8 to 6	360	_	_	1	11PFM
LMZ13608/10	8/10	6 to 36	0.8 to 6	360	_	_	1	11PFM
LMZ22003/05	3/5	6 to 20	0.8 to 6	650 to 950	1	_	1	7TO-PMOD
LMZ23603/05	3/5	6 to 36	0.8 to 6	650 to 950	1	_	1	7TO-PMOD
LMZ22008/10	8/10	6 to 20	0.8 to 6	315 to 600	1	_	1	11PFM
LMZ23608/10	8/10	6 to 36	0.8 to 6	315 to 600	1	_	1	11PFM
LMZ30602/04/06	2/4/6	2.95 to 6	0.8 to 3.6	500 to 2000	1	_	1	39B1QFN
LMZ31503	3	4.5 to 14.5	0.8 to 5.5	330 to 780	1	_	1	47B1QFN
LMZ31506/H	6	4.5 to 14.5	0.6/1.2 to 5.5	250 to 780	1	✓	1	47B1QFN
LMZ31704/07/10	4/7/10	2.95 to 17	0.6 to 5.5	200 to 2000	1	✓	1	42B3QFN
LMZ31520/30	20/30	2.95 to 15	0.6 to 3.6	300 to 800		_	1	72B2QFN
LMZ35003	2.5	7 to 50	2.5 to 15	400 to 1000	✓	_	1	41B1QFN
LMZ36002	2	4.5 to 60	2.5 to 7.5	200 to 1000	1	_	1	43B3QFN
LMZ34002	2	4.5 to 40	-3 to -17	500 or 800	✓	_	✓	41B1QFN

Regulators

SIMPLE SWITCHER regulators

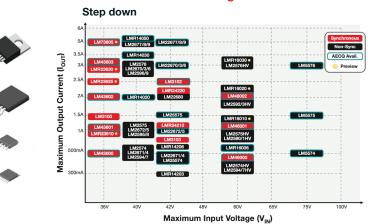
When to use: For designs that require input voltage up to 75V and a balance between EOU and flexibility

SIMPLE SWITCHER® regulators Step up, buck-boost, SEPIC, flyback



- **Exceptional flexibility-**Adjustable or synchronizable frequency, adjustable current limit, precision enable, soft start
- Versatile portfolio-Both buck and boost devices that can be optimized for solution size or simple scalability

SIMPLE SWITCHER® regulators

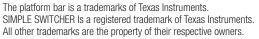


Step up, buck-boost, SEPIC, flyback regulators

Device	Switch Current (A)	Input Voltage (V)	Output Voltage (V)	Frequency (kHz)	Freq Sync	Enable	Soft Start	Packaging
LMR62421	2.1	2.7 to 5.5	3 to 24	1600	_	1	✓	5SOT-23, 6WSON
LMR62014	1.4	2.7 to 14	3 to 20	1600	_	1	_	5SOT-23
LMR61428	2.85	1.2 to 14	3 to 14	2000	_	1	_	8VSSOP
LMR64010	1	2.7 to 14	3 to 40	1600	_	1	_	5SOT-23
LMR70503	0.32	2.7 to 5.5	-0.9 to -5.5	500 min	_	1	_	8DSBGA
LM2585	3	4 to 40	1.23 to 60	100	_	_	_	5DDPAK/TO-263, 5TO-220
LM2586	3	4 to 40	1.23 to 60	100 to 200	1	1	_	7DDPAK/TO-263, 7TO-220
LM2587	5	4 to 40	1.23 to 60	100	_	_	_	5DDPAK/TO-263, 5TO-220
LM2588	5	4 to 40	1.23 to 60	100 to 200	1	✓	-	7DDPAK/TO-263, 7TO-220

Cton down wouldtown

Device	Output Current (A)	Input Voltage (V)	Output Voltage (V)	Frequency (kHz)	Freq Sync	Enable	Soft Start	Synchronous	Fixed Output Versions Available	AEC- Q100	Packaging
LM2676/7	3/5	8 to 40	1.23 to 37	260	_	_	_	_	3.3/5/12	_	14VSON, 7DDPAK/TO- 263, 7TO-220
LM2675/4	1/0.5	6.5 to 40	1.23 to 27	260	_	_	_	_	3.3/5/12	_	16WSON, 8PDIP, 8SOIC
LM2596/5	3/1	4.5 to 40	3.3 to 37	150	_	_	_	_	3.3/5/12	_	5DDPAK/TO-263, 5TO-220
LM2594	0.05	4.5 to 40	3.3 to 37	150	_	_	_	_	3.3/5/12	_	8PDIP, 8SOIC
LM2576/5/HV	3/1	4 to 60	3.3 to 37	63	_	_	_	_	3.3/5/12/15	_	5DDPAK/TO-263, 5TO-220
LM2574HV	0.5	4 to 60	3.3 to 37	63	_	_	_	_	3.3/5/12/15	_	14SOIC, 8PDIP
LM22671/4	0.5	4.5 to 42	1.285 to 37	200 to 1000	√/-	✓	√/-	_	5	✓	8SO PowerPAD
LM22672/5	1	4.5 to 42	1.285 to 37	200 to 1000	√/-	✓	√/-	_	5	✓	8SO PowerPAD
LM22680	2	4.5 to 42	1.285 to 37	200 to 1000	✓	✓	✓	_	-	✓	8SO PowerPAD
LM22670/73/76	3	4.5 to 42	1.285 to 37	200 to 1000	√/-/-	√/-/√	/-/√/-	_	5	✓	8SO PowerPAD, 7TO-263
LM22677/78/79	5	4.5 to 42	1.285 to 37	200 to 1000	√/-/-	√/√/-	/-/-/✓	_	5	✓	7TO-263
LMR14006/6006	0.6	4 to 40/60	.8 to 30/55	700 or 2100	_	_	_	_	_	✓	6SOT
LMR14020/30/50	2/3/5	4 to 40	1 to 36	200 to 2500	✓	✓	✓	_	_	✓	8SO PowerPAD
LM43600/01/02/03	0.5/1/2/3	3.5 to 36	1 to 28	200 to 2200	✓	✓	✓	✓	_	✓	16HTSSOP
LM46000/01/02	0.5/1/2	3.5 to 36	1 to 28	200 to 2200	✓	✓	✓	✓	_	✓	16HTSSOP





IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have *not* been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Products Applications

logic.ti.com

Audio www.ti.com/audio Automotive and Transportation www.ti.com/automotive **Amplifiers** amplifier.ti.com Communications and Telecom www.ti.com/communications **Data Converters** dataconverter.ti.com Computers and Peripherals www.ti.com/computers **DLP® Products** www.dlp.com Consumer Electronics www.ti.com/consumer-apps DSP dsp.ti.com **Energy and Lighting** www.ti.com/energy Clocks and Timers www.ti.com/clocks Industrial www.ti.com/industrial Interface interface.ti.com Medical www.ti.com/medical

Power Mgmt power.ti.com Space, Avionics and Defense www.ti.com/space-avionics-defense

Security

www.ti.com/security

Microcontrollers microcontroller.ti.com Video and Imaging www.ti.com/video

RFID www.ti-rfid.com

Logic

OMAP Applications Processors www.ti.com/omap TI E2E Community e2e.ti.com

Wireless Connectivity www.ti.com/wirelessconnectivity